

PRODUCT DATASHEET Laura series

last update 21/8/2013

DETAILS

Product Number CA11355_LAURA-M

FamilyLauraTypeAssemblyColorblack

Diameter 21.6 x 21.6 mm

Height 13,1 mm

Style square

Optic Material PMMA

Holder Material PC

Fastening tape

Status ready

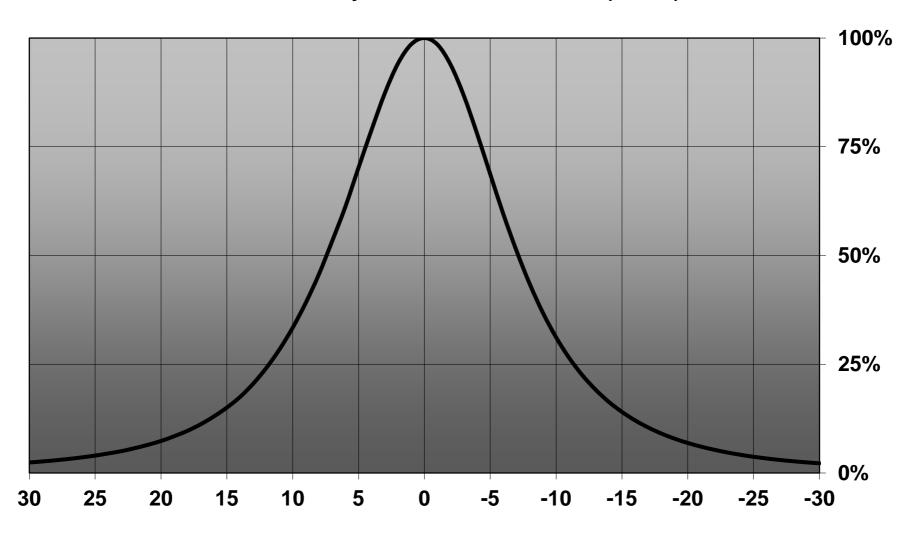
ROHS Comliant Yes

Date Updated 25/02/2013

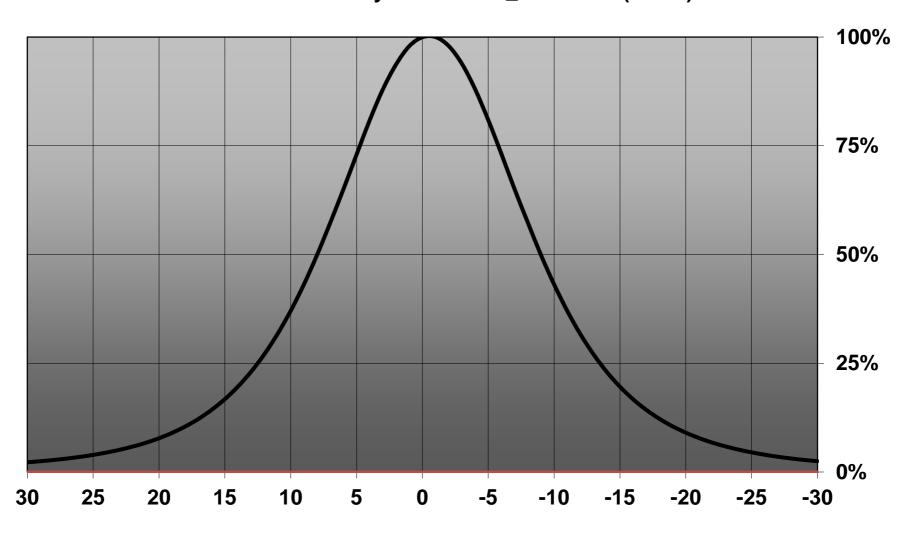
OPTICAL PROPERTIES

	Viewing	Light	Effi-		
LED	Angle	Beam	ciency	cd/lm	Connector
Z5	sim: 15	Medium	-	-	-
XP-E-HEW	27 deg	Medium	85 %	2.600	-
XP-E2	28 deg	Medium	83 %	2.980	-
XT-E	28 deg	Medium	-	2.380	-
XP-E	30 deg	Medium	83 %	2.690	-
XP-G2	32 deg	Medium	83 %	2.400	-
H35C1 (LEMWA33)	33 deg	Medium	82 %	2.300	-
XP-G	34 deg	Medium	83 %	2.400	-

Relative intensity of CA11360_LAURA-D_(XP-E2)

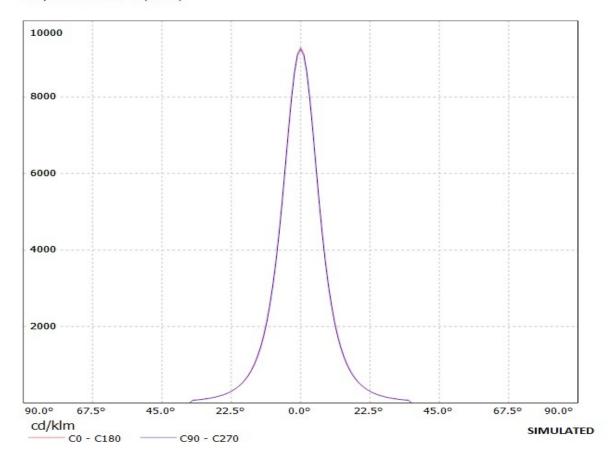


Relative intensity of CA11360_LAURA-D-(XPG2)



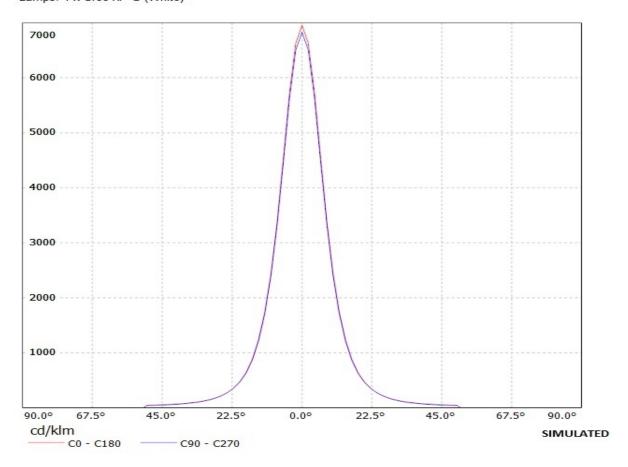
Ledil Oy CA11360_Laura-D-XP-tape CA11360_Laura-D-XP-tape / LDC (Linear)

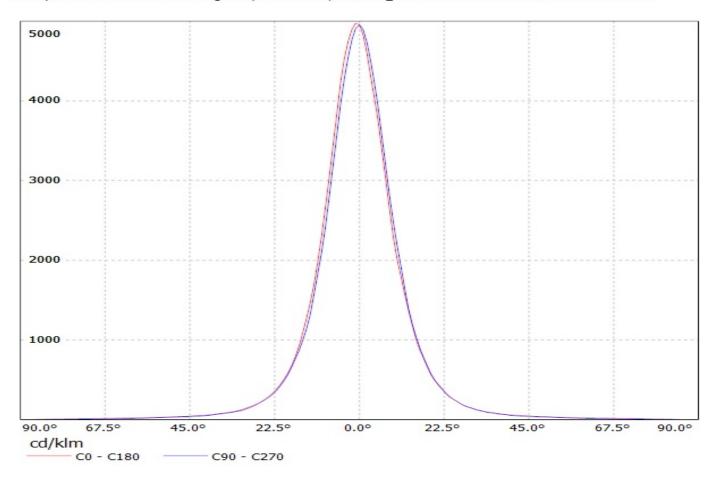
Luminaire: Ledil Oy CA11360_Laura-D-XP-tape CA11360_Laura-D-XP-tape Lamps: 1 x Cree XP-E (White)



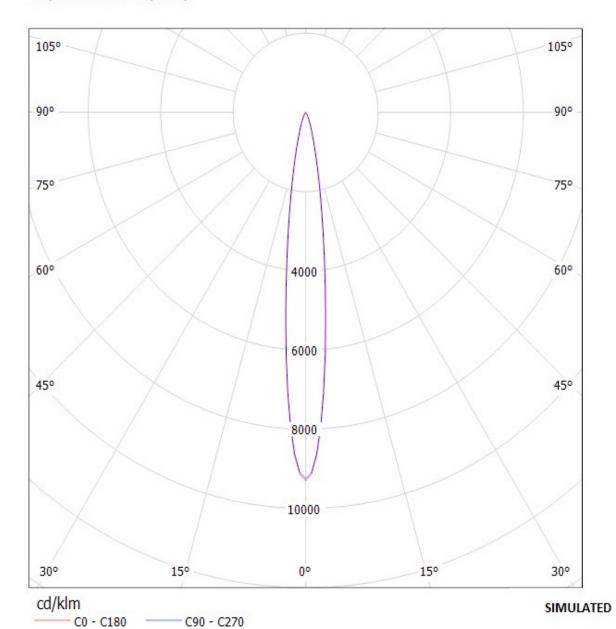
Ledil Oy CA11360_Laura-D-XP-G-tape CA11360_Laura-D-XP-G-tape / LDC (Linear)

Luminaire: Ledil Oy CA11360_Laura-D-XP-G-tape CA11360_Laura-D-XP-G-tape Lamps: $1 \times Cree XP-G$ (White)

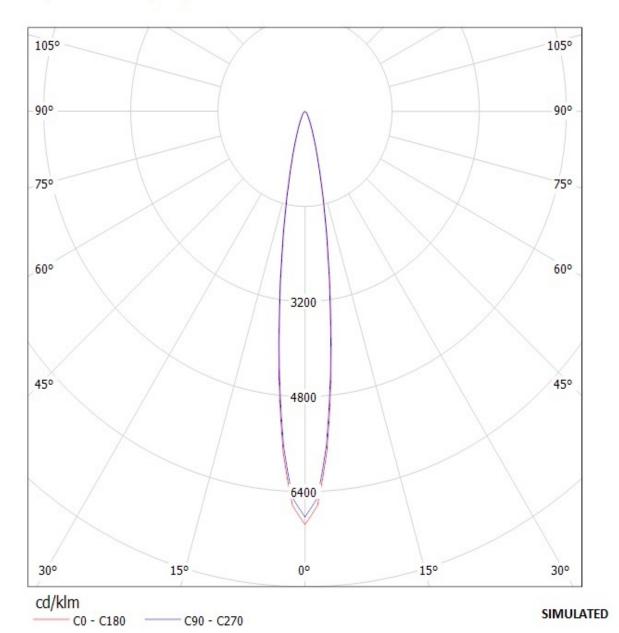


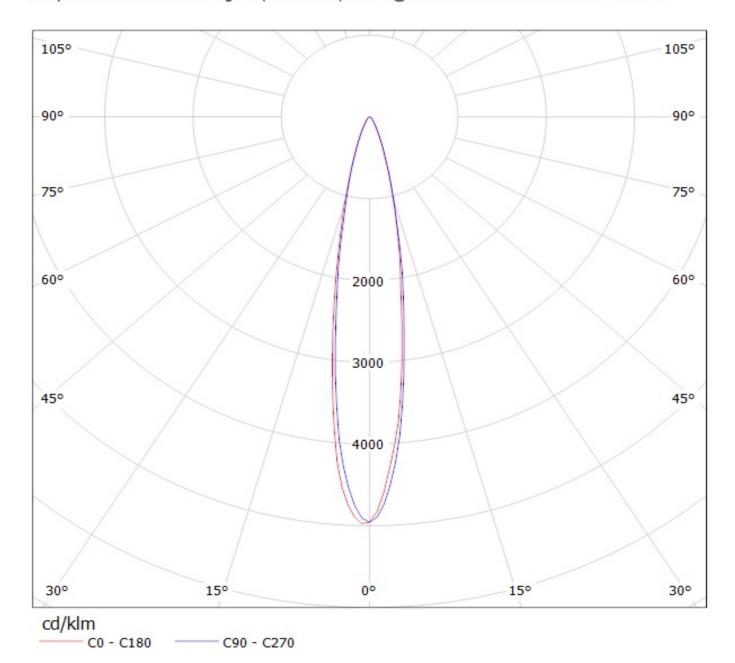


Luminaire: Ledil Oy CA11360_Laura-D-XP-tape CA11360_Laura-D-XP-tape Lamps: 1 x Cree XP-E (White)



Luminaire: Ledil Oy CA11360_Laura-D-XP-G-tape CA11360_Laura-D-XP-G-tape Lamps: 1 x Cree XP-G (White)





NOTE: The typical divergence will be changed by different color, chip size and chip position tolerance. The typical total divergence is the full angle measured where the luminous intensity is half of the peak value.

GENERAL INFORMATION

- Product series especially designed & optimized for series of LEDs.
- Special care taken to make light distribution as uniform as possible.
- Fastening to heat sink with a PU foam adhesive tape of automotive grade. Please find fastening details by clicking link: http://www.ledil.com/datasheets/DataSheet_TAPE.pdf
- NOTE 1: We advise customer to ensure the suitability and sufficiency of the bond in the end product. For example, mechanical stress, vibration and holes on the surface of the circuit boar weaken the strength of the tape.
- NOTE 2: Assembly to the surface must be made straight, so the tape bonds constant and balanced with fastening surface. Slanted assembly might cause unbalanced bond to the surface. All surfaces where tape is applied must be clean, dry and free from grease and dirt.

If cleaning of PCB surfaces is needed, please follow strictly the cleaning instructions of your LED manufacturer - this is important as cleaning shall under no circumstances damage LEDs or other electronics components on the PCB.

Further note that optical components shall not be cleaned with any chemicals - only micro fiber cloth may be used to remove fingerprints or other traces from handling.